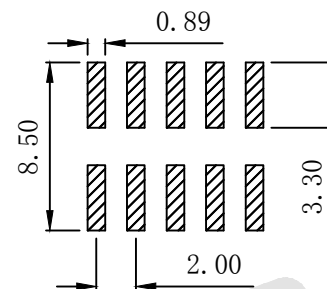
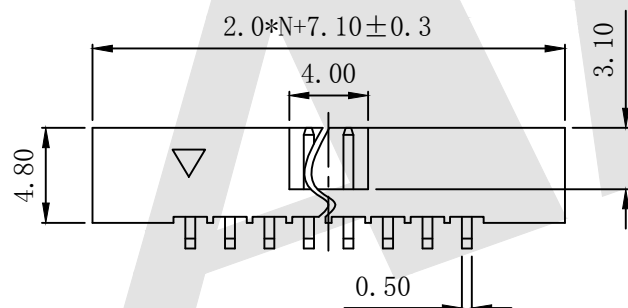
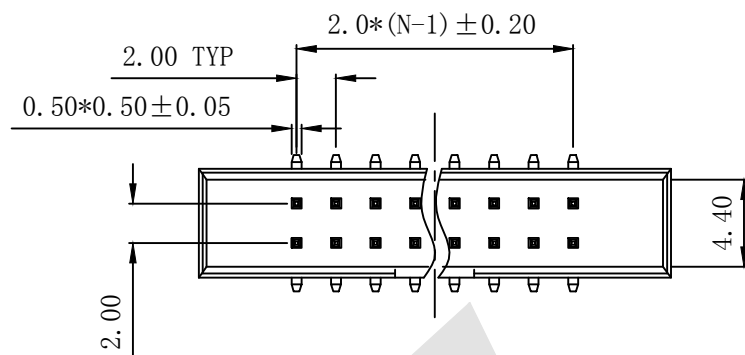


HSF



ROHS



PCB LAYOUT

SPECIFICATION

Current Rating: 2.0Amp
Insulation Resistance: 1000MΩ min
Contact Resistance: 20MΩ max
Withstand Voltage: 500V AC/DC
Operating Temperature: -40°C to +105°C
Contact Material: Brass
Contact Plating: Au or Sn Over Ni
Insulator Material: PA6T+30%GF UL 94V-0

Ordering Code:

BHCM05 - X - X - X - X - X
① ② ③ ④ ⑤ ⑥

- ① Series No:
② No. of Contacts
06 08 10 12 14 16 18
20 22 24 26 28 30 34
36 40 44 50 60 68
③ Contact Plating:
G0:Gold flash S0:Selective
G1:3U" Gold S1:Selective 3u"
G2:5u" Gold S2:Selective 5u"
G3:10u" Gold S3:Selective 10u"
G4:15u" Gold S4:Selective 15u"
G5:30u" Gold S5:Selective 30u"
SN:Tin
④ Color Insulator
B:Black
U:Blue
W:White
⑤ Insulator Material
B:PA6T
C:LCP
E:PA9T
⑥ Packing
A:Tray
B:Bag
T:Tube
U:Tube+CAP
R:Tape&Reel
W:Tape&Reel+CAP

Unless Otherwise specified tolerance

X. ±0.35 X.XX: ±0.20
X.X: ±0.25 X.XXX: ±0.15

SCALE: As Shown UNIT: mm

DRAW YG ZHONG DATE 01/05/2016

CHECK BobYang DATE 01/05/2016



3rd ANGLE PROJECTION

Antenk ANTENK ELECTRONICS CO., LTD
Http://www.antenk.com
E-mail:sales@antenk.com

TITLE:
2.00mm Box Header SMT H=4.8

DRAWING NO: BHCM05-XXXXX

PRODUCT NO: BHCM05-XXXXX

REV

DESCRIPTION

DATE